



PE8215CM N and P Channel Enhancement Mode Power MOSFET

PE8215CM Description

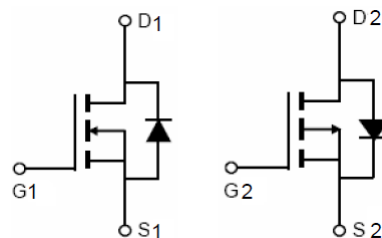
The PE8215CM uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.

PE8215CM General Features

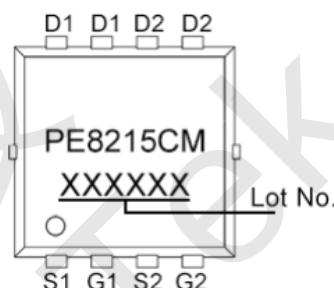
- **N-Channel**
 - $V_{DS} = 20V$, $I_D = 20A$
 $R_{DS(ON)} < 11m\Omega$ @ $V_{GS}=4.5V$
 $R_{DS(ON)} < 15m\Omega$ @ $V_{GS}=2.5V$
- **P-Channel**
 - $V_{DS} = -20V$, $I_D = -20A$
 $R_{DS(ON)} < 21m\Omega$ @ $V_{GS}=-4.5V$
 $R_{DS(ON)} < 28m\Omega$ @ $V_{GS}=-2.5V$
- High Power and current handling capability
- Lead free product is acquired
- Surface Mount Package

PE8215CM Application

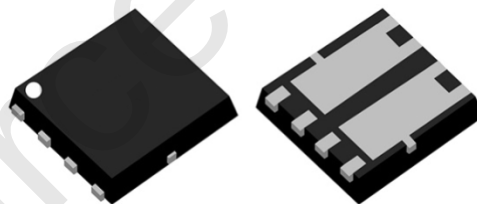
- DC motor
- PWM applications



Schematic diagram



Marking and pin assignment



PDFN3.3x3.3-8L

PE8215CM Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V_{DS}	20	-20	V
Gate-Source Voltage	V_{GS}	± 12	± 12	V
Drain Current-Continuous	I_D	20	-20	A
Drain Current-Continuous (TC=100°C)	I_D	13	-13	A
Pulsed Drain Current (Note 1)	I_{DM}	80	-80	A
Maximum Power Dissipation	P_D	16.7	21	W
Single Pulsed Avalanche Energy (L=0.1mH)	E_{AS}	23	26	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150		°C

PE8215CM Thermal Characteristic

Parameter	Symbol	N-Channel	P-Channel	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	7.5	6	°C/W



PE8215CM N-Channel Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	20	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=18V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	± 100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.45	0.7	1.1	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=5A$	-	9	11	m Ω
		$V_{GS}=2.5V, I_D=3A$	-	12	15	m Ω
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$V_{DS}=10V, V_{GS}=0V,$ $F=1.0MHz$	-	835	-	pF
Output Capacitance	C_{oss}		-	130	-	pF
Reverse Transfer Capacitance (Note 4)	C_{rss}		-	120	-	pF
Gate Resistance	R_g	$V_{DS}=0V, V_{GS}=0V, F=1.0MHz$	-	1.2	-	Ω
Switching Characteristics						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V, R_L=1\Omega,$ $V_{GS}=4.5V, R_G=3\Omega$	-	13	-	nS
Turn-on Rise Time	t_r		-	63.8	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	38	-	nS
Turn-Off Fall Time	t_f		-	8.2	-	nS
Total Gate Charge	Q_g	$V_{DS}=10V, I_D=5A, V_{GS}=4.5V$	-	20	-	nC
Gate-Source Charge	Q_{gs}		-	1.7	-	nC
Gate-Drain Charge	Q_{gd}		-	2.6	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$V_{GS}=0V, I_S=1A$	-	-	1.2	V
Diode Forward Current (Note 2)	I_S		-	-	20	A
Reverse Recovery Time	t_{rr}	$I_F=5A, di/dt=60A/\mu s$	-	29.4	-	nS
Reverse Recovery Charge	Q_{rr}		-	6.8	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.



PE8215CM Typical Electrical and Thermal Characteristics

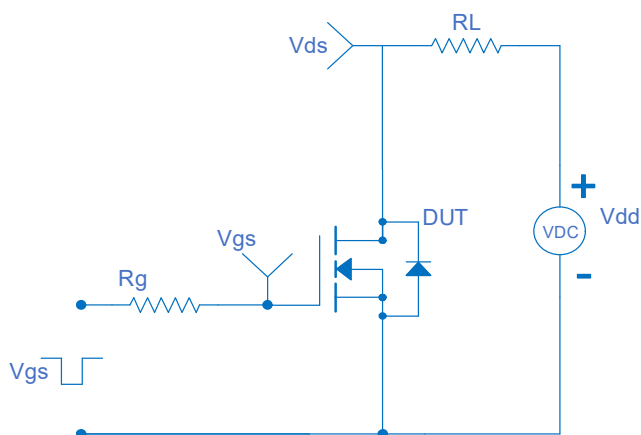


Figure 1 Switching Test Circuit

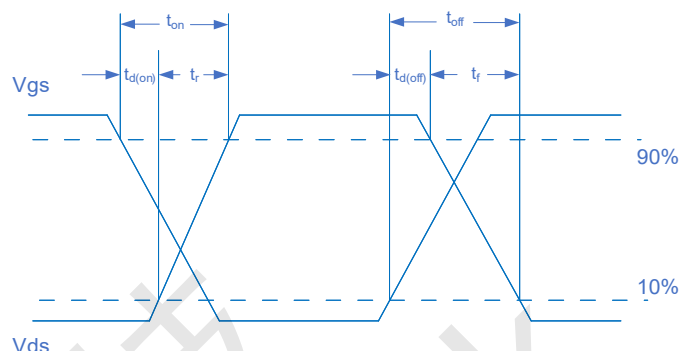


Figure 2 Switching Waveform

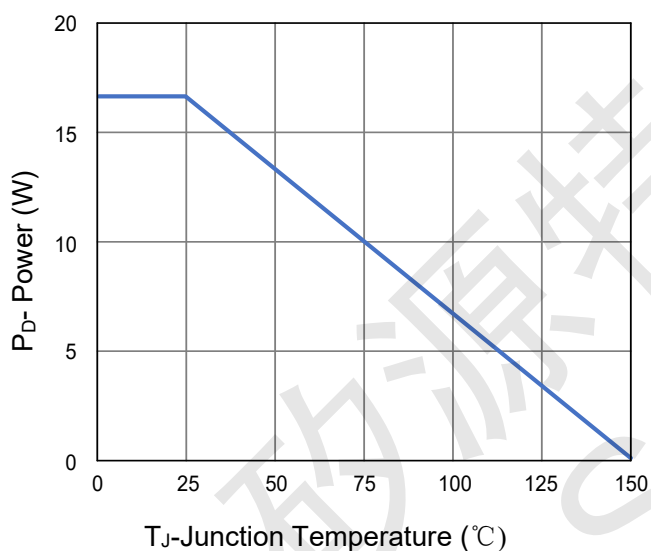


Figure 3 Power De-rating

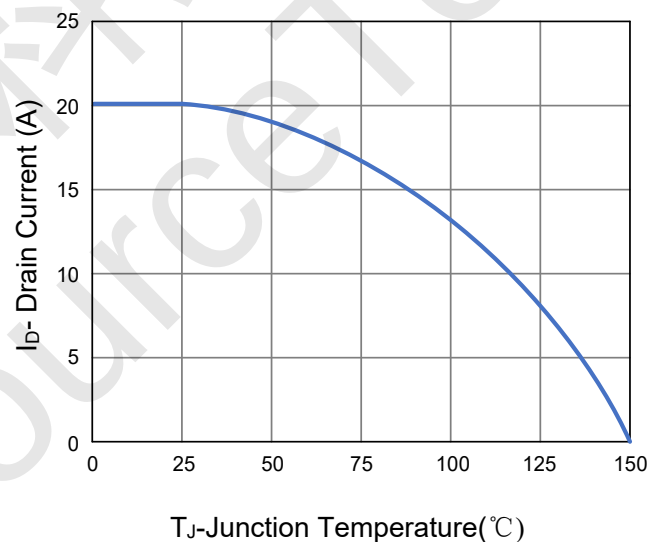


Figure 4 Drain Current

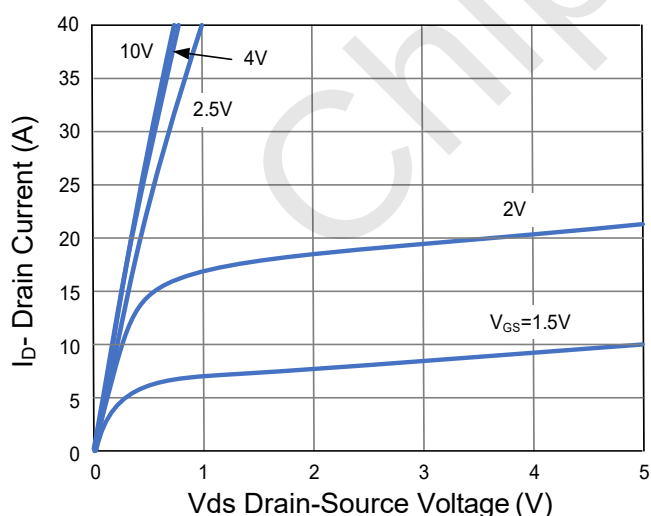


Figure 5 Output Characteristics

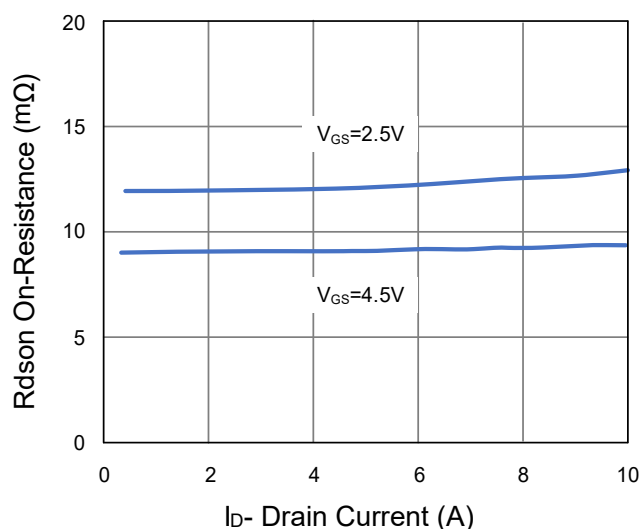


Figure 6 Rdson vs Drain Current

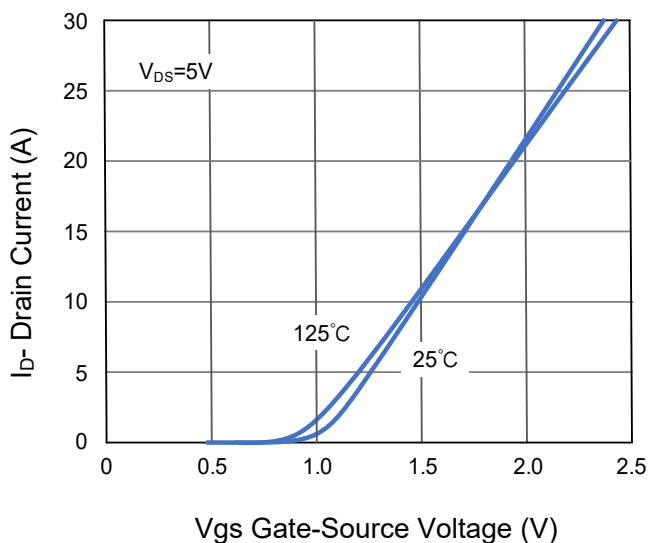


Figure 7 Transfer Characteristics

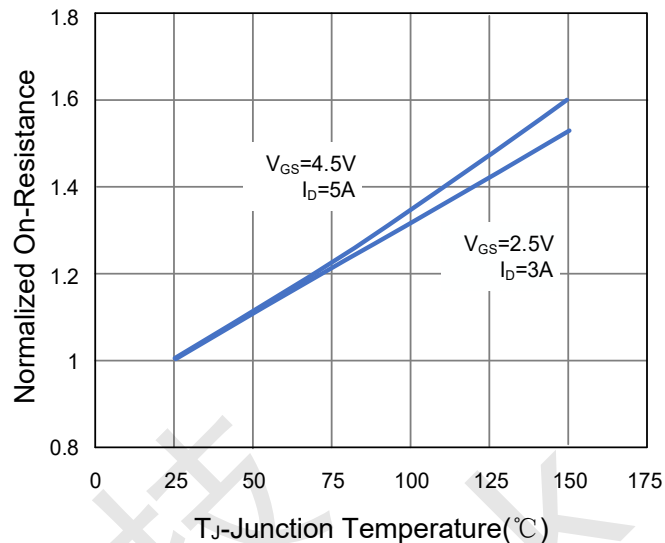


Figure 8 Rdson vs Junction Temperature

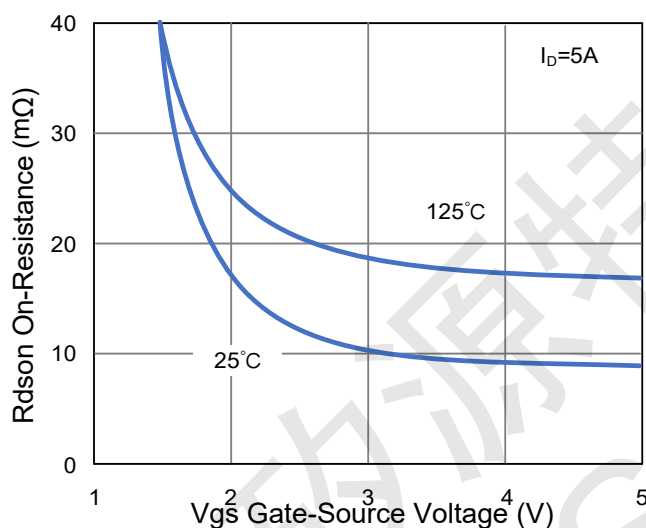


Figure 9 Rdson vs Vgs

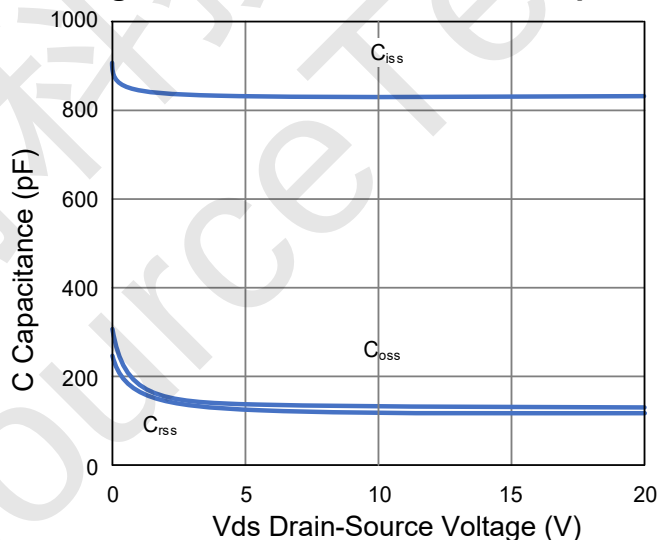


Figure 10 Capacitance vs Vds

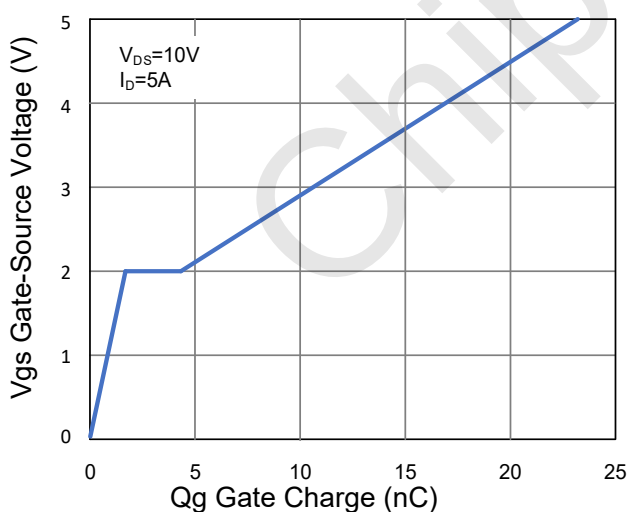


Figure 11 Gate Charge

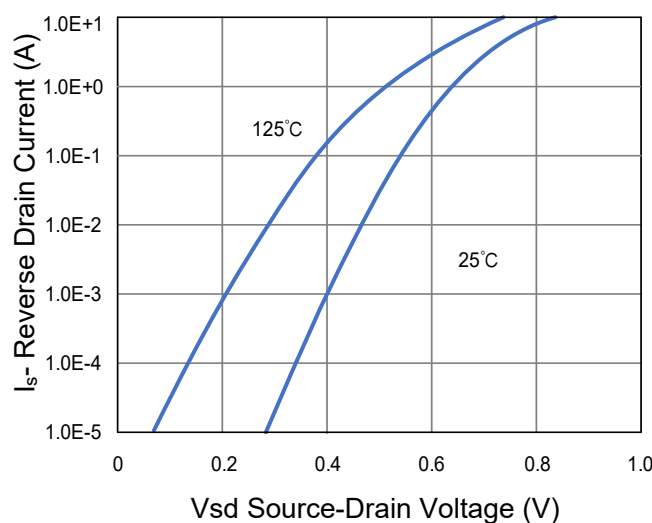


Figure 12 Source- Drain Diode Forward

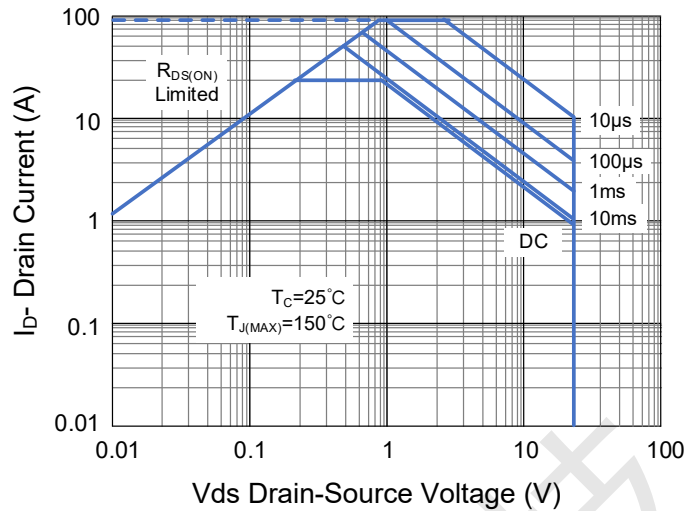


Figure 13 Safe Operation Area

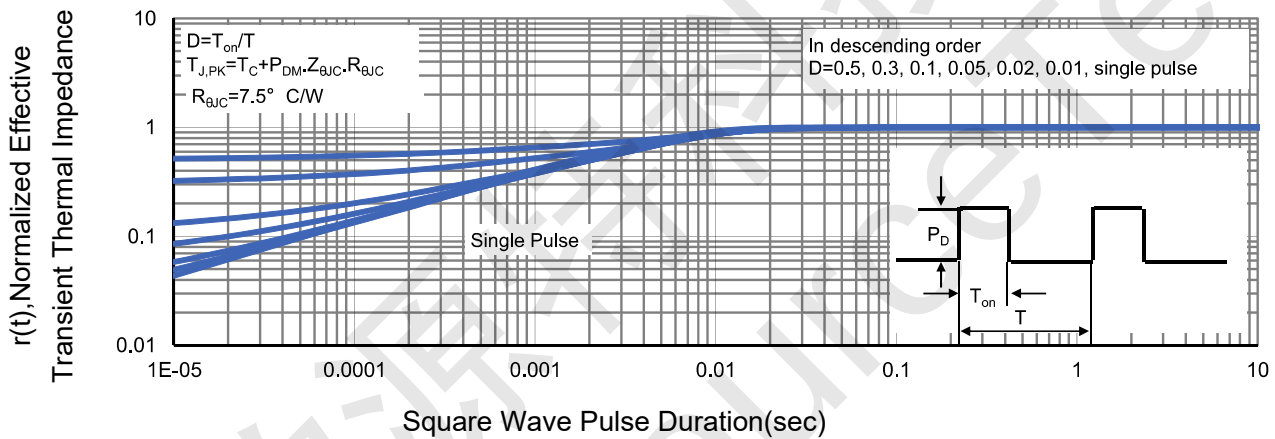


Figure 14 Normalized Maximum Transient Thermal Impedance



PE8215CM P-Channel Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V$	-	-	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	± 100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.45	-0.7	-1.1	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-5A$	-	17.5	21	m Ω
		$V_{GS}=-2.5V, I_D=-3A$	-	23	28	m Ω
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V,$ $F=1.0MHz$	-	1200	-	pF
Output Capacitance	C_{oss}		-	140	-	pF
Reverse Transfer Capacitance (Note 4)	C_{rss}		-	120	-	pF
Switching Characteristics						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-10V, I_D=-1A, R_L=1\Omega,$ $V_{GS}=-4.5V, R_G=3\Omega$	-	15	-	nS
Turn-on Rise Time	t_r		-	98.4	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	42.4	-	nS
Turn-Off Fall Time	t_f		-	19.6	-	nS
Total Gate Charge	Q_g	$V_{DS}=-10V, I_D=-5A,$ $V_{GS}=-4.5V$	-	21	-	nC
Gate-Source Charge	Q_{gs}		-	2.3	-	nC
Gate-Drain Charge	Q_{gd}		-	2.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$V_{GS}=0V, I_S=-1A$	-	-	-1.2	V
Diode Forward Current (Note 2)	I_S		-	-	-8	A
Reverse Recovery Time	t_{rr}	$I_F=-5A, di/dt=100A/\mu s$	-	30	-	nS
Reverse Recovery Charge	Q_{rr}		-	11	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.



PE8215CM Typical Electrical and Thermal Characteristics

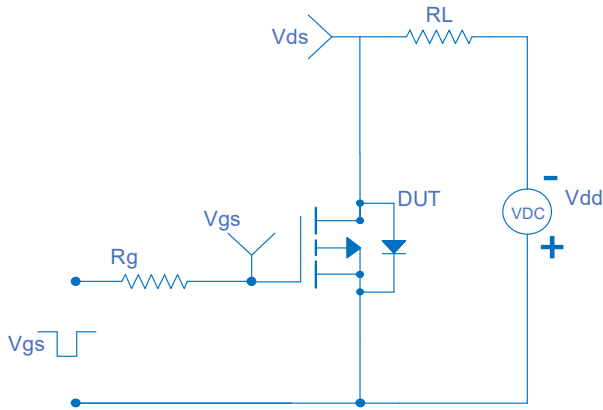


Figure 1 Switching Test Circuit

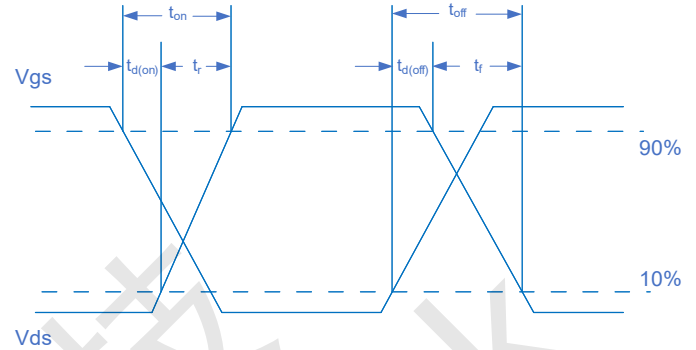


Figure 2 Switching Waveform

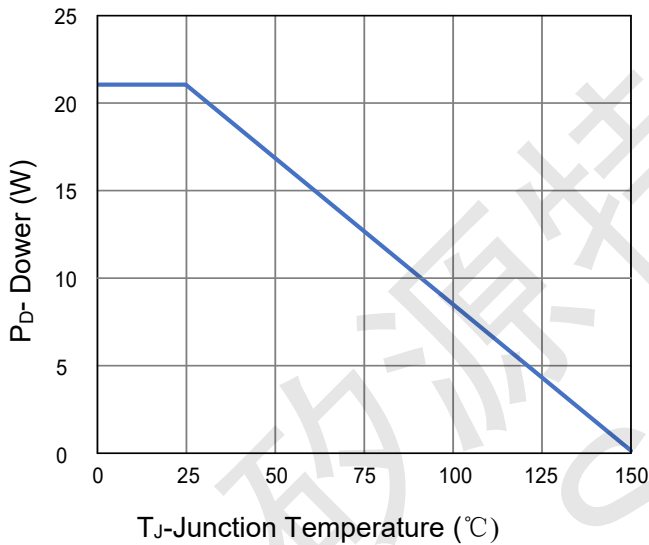


Figure 3 Power De-rating

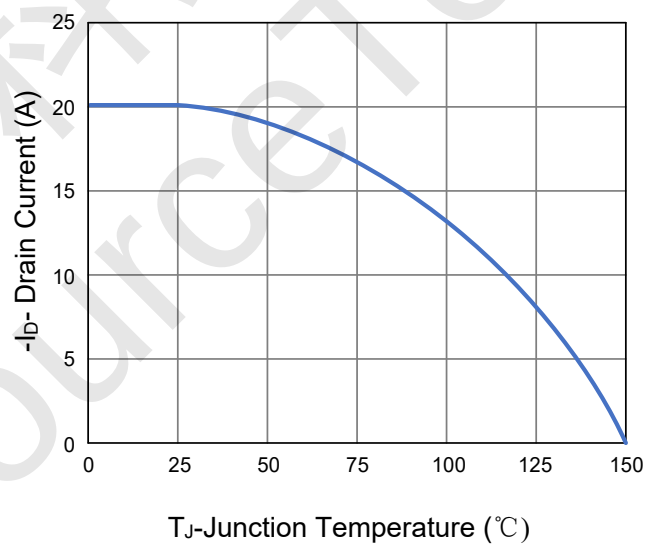


Figure 4 Drain Current

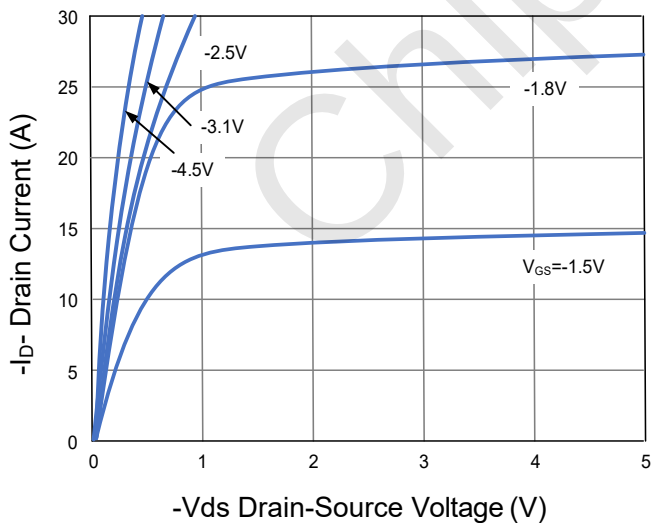


Figure 5 Output Characteristics

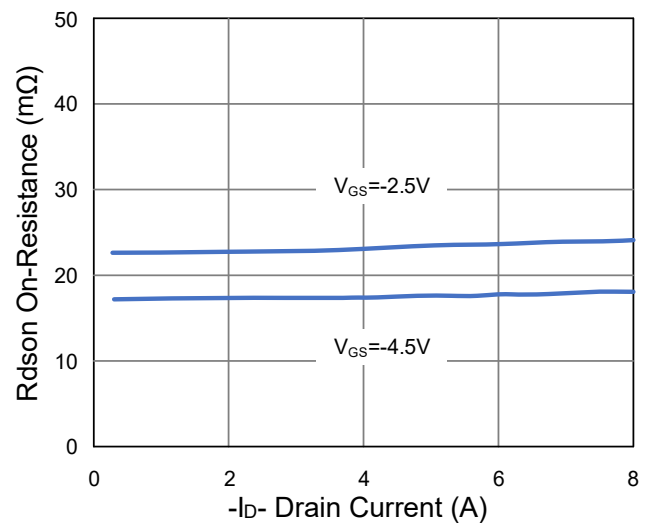


Figure 6 Rdson vs Drain Current

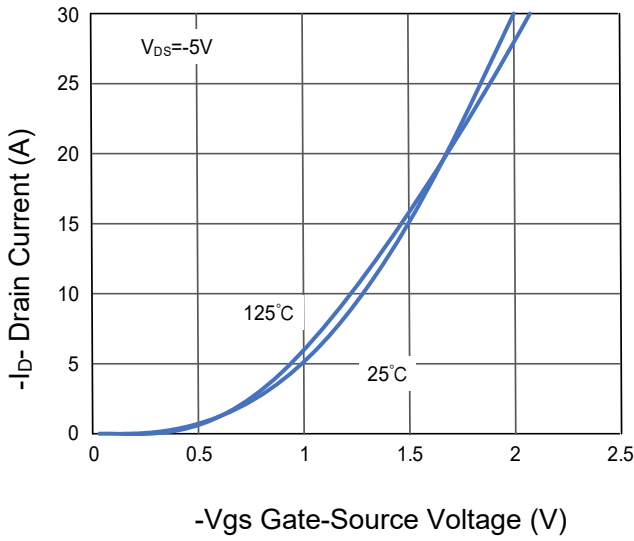


Figure 7 Transfer Characteristics

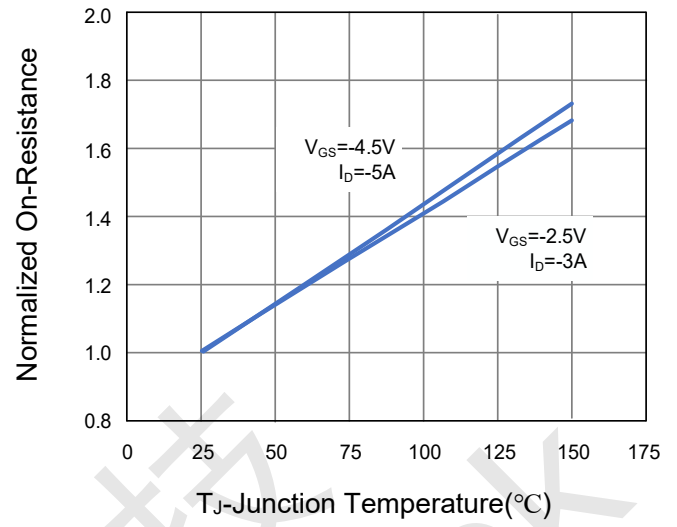


Figure 8 $R_{DS(on)}$ vs Junction Temperature

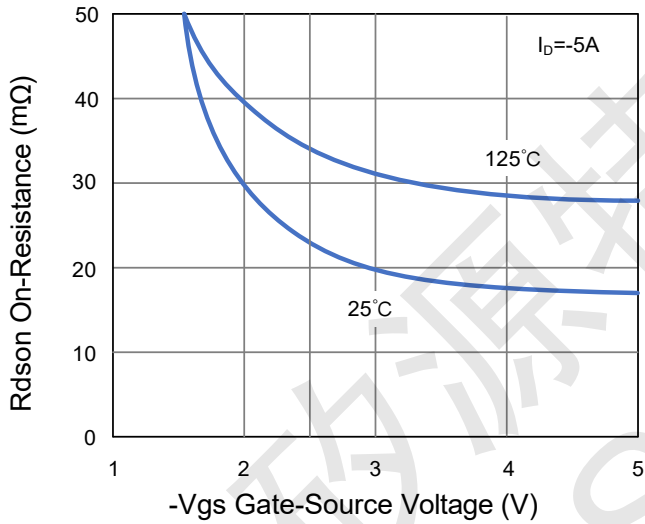


Figure 9 $R_{DS(on)}$ vs V_{GS}

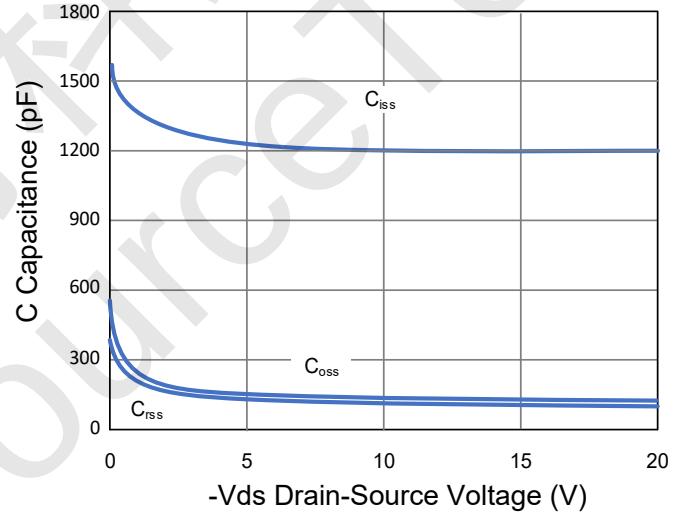


Figure 10 Capacitance vs V_{DS}

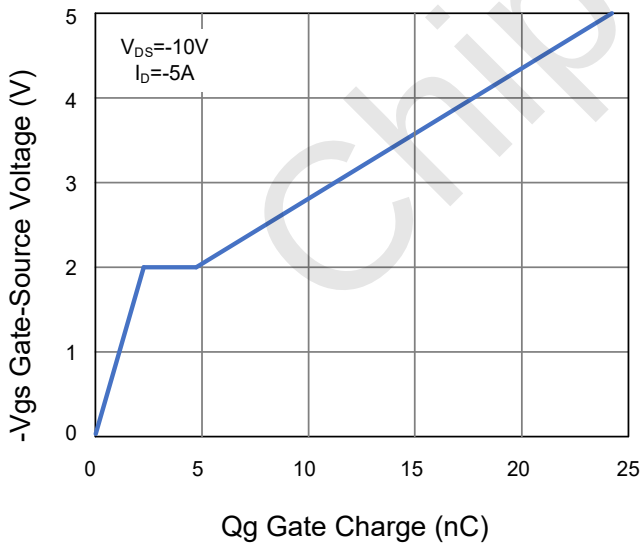


Figure 11 Gate Charge

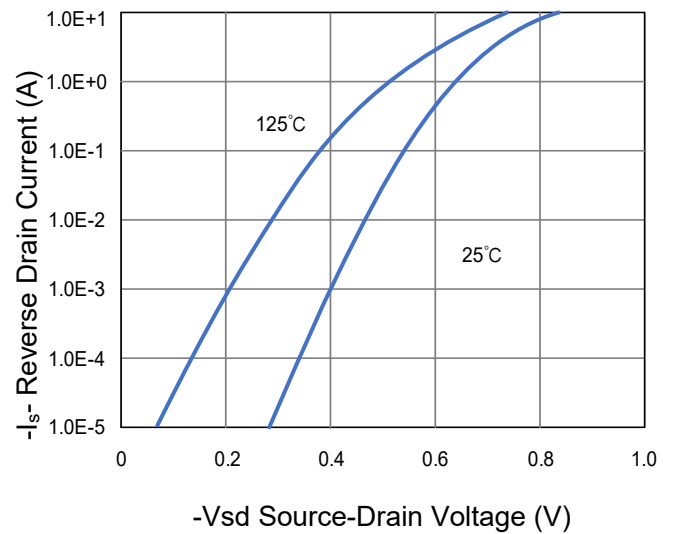


Figure 12 Source- Drain Diode Forward

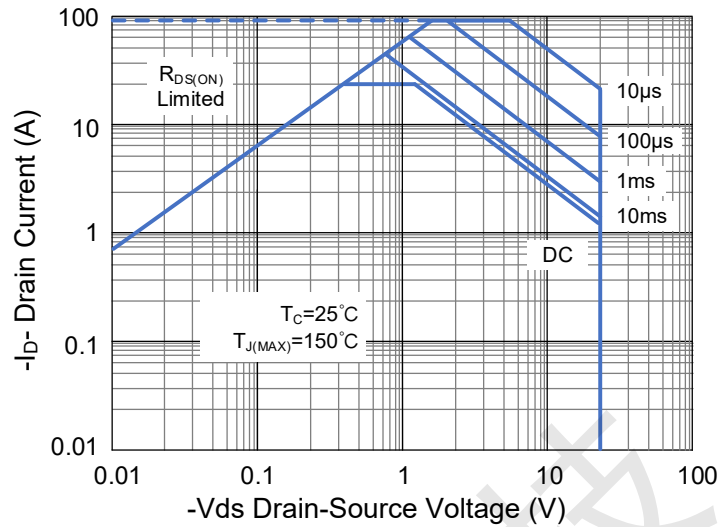


Figure 13 Safe Operation Area

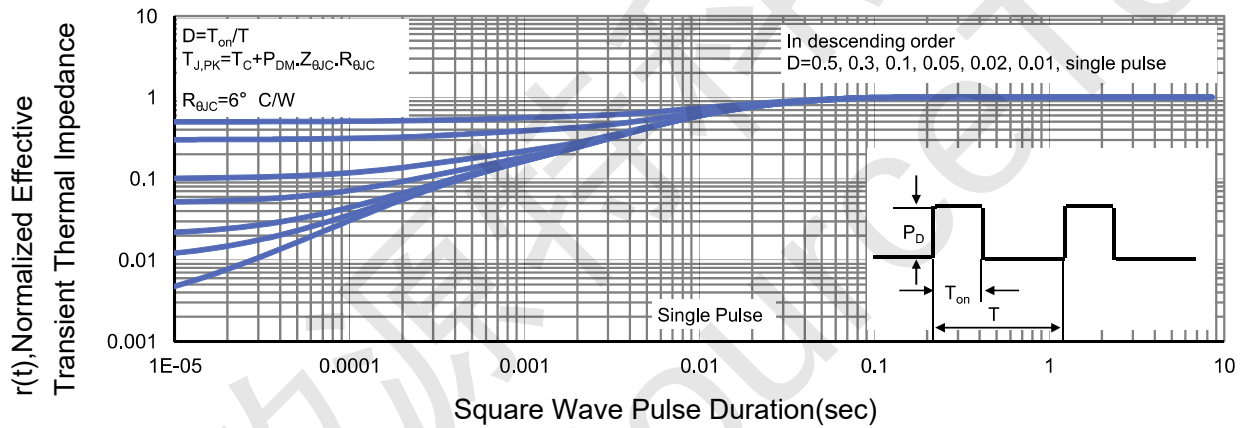
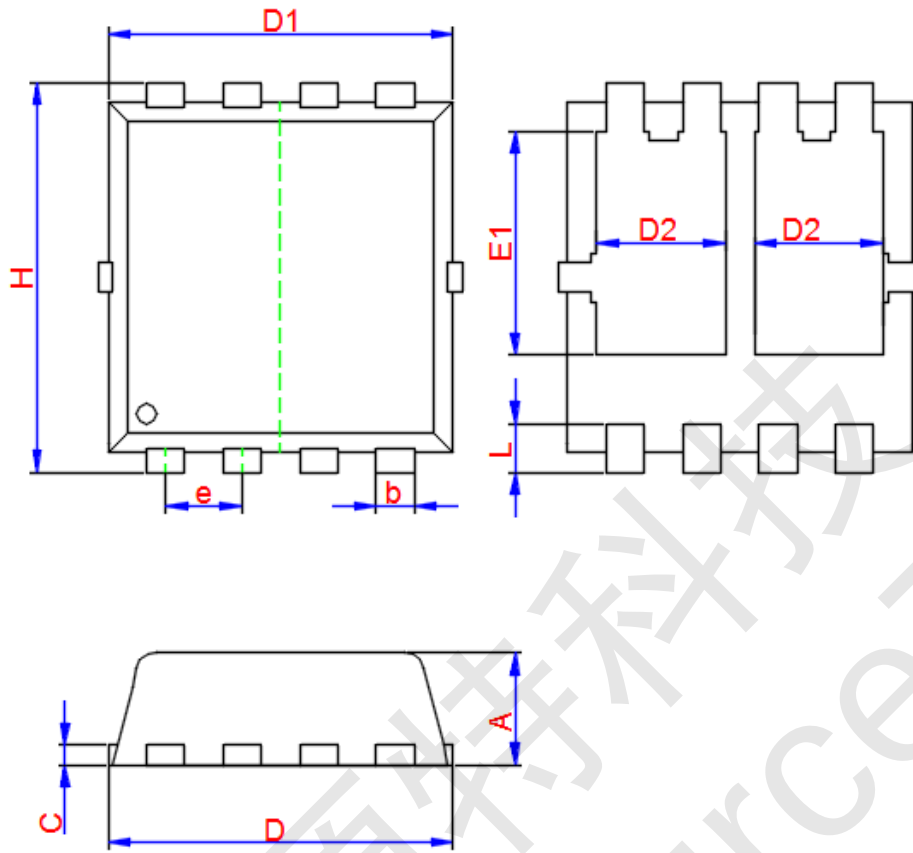


Figure 14 Normalized Maximum Transient Thermal Impedance



PE8215CM PDFN3.3x3.3-8L Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	0.675	0.775	0.875
b	0.300TYP.		
C	0.152TYP.		
D	3.100	3.300	3.500
D1	3.050	3.150	3.250
D2	0.835	1.035	1.235
e	0.650TYP.		
E1	1.530	1.730	1.930
H	3.150	3.350	3.550
L	0.280	0.380	0.480